RENESAS

HAF2021(L), HAF2021(S)

Silicon N Channel MOS FET Series Power Switching

> REJ03G0179-0200Z (Previous ADE-208-1459A(Z)) Rev.2.00 Mar.05.2004

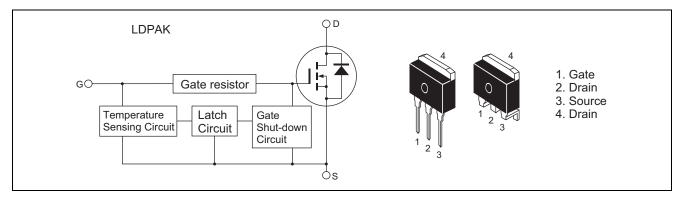
Description

This FET has the over temperature shut–down capability sensing to the junction temperature. This FET has the built–in over temperature shut–down circuit in the gate area. And this circuit operation to shut–down the gate voltage in case of high junction temperature like applying over power consumption, over current etc.

Features

- Logic level operation (6 V Gate drive)
- High endurance capability against to the short circuit
- Built-in the over temperature shut-down circuit
- Latch type shut–down operation (Need 0 voltage recovery)

Outline



Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	60	V
Gate to source voltage	V _{GSS}	16	V
Gate to source voltage	V _{GSS}	-2.5	V
Drain current	ID	50	A
Drain peak current	Note1 I _{D(pulse)}	100	A
Body-drain diode reverse drain current	I _{DR}	50	A
Channel dissipation	Pch Note2	100	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. $PW \le 10\mu s$, duty cycle $\le 1 \%$

2. Value at Ta = 25°C

Typical Operation Characteristics

Item	Symbol	Min	Тур	Мах	Unit	Test Conditions
Input voltage	V _{IH}	3.5	_	_	V	
	VIL		_	1.2	V	
Input current	I _{IH1}		_	100	μΑ	Vi = 6 V, V _{DS} = 0
(Gate non shut down)	I _{IH2}		_	50	μΑ	Vi = 3.5 V, V _{DS} = 0
	IIL		_	1	μΑ	Vi = 1.2 V, V _{DS} = 0
Input current	I _{IH(sd)1}		0.6	_	mA	Vi = 6 V, V _{DS} = 0
(Gate shut down)	I _{IH(sd)2}		0.35	_	mA	Vi = 3.5 V, V _{DS} = 0
Shut down temperature	T _{sd}		175	_	°C	Channel temperature
Gate operation voltage	V _{OP}	3.5	_	12	V	

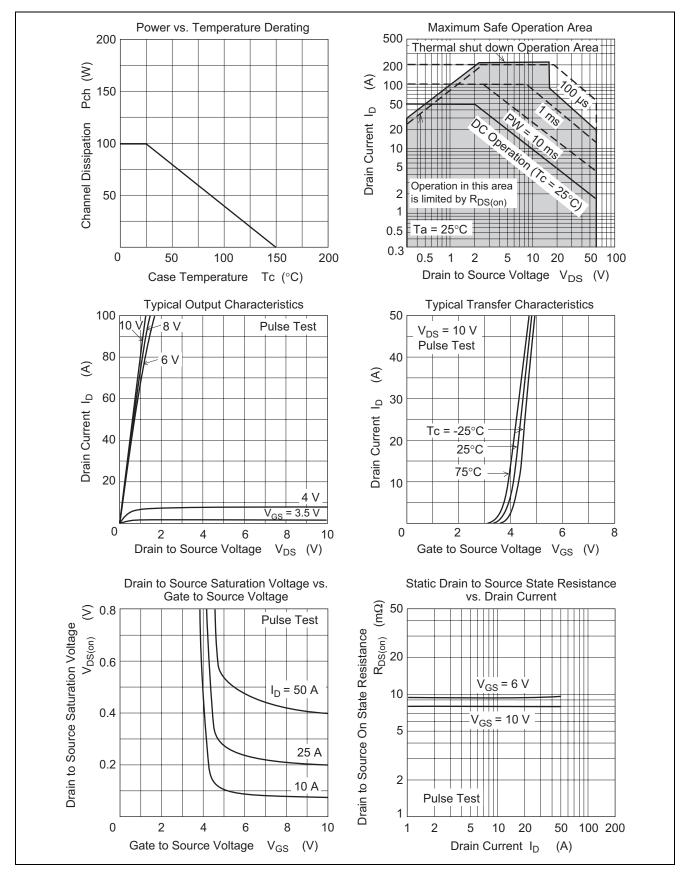
Electrical Characteristics

						$(Ta = 25^{\circ}C)$
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain current	I _{D1}	90	_		А	$V_{GS} = 6 V, V_{DS} = 10 V$
Drain current	I _{D2}		_	10	mA	$V_{GS} = 1.2 \text{ V}, V_{DS} = 10 \text{ V}$
Drain to source breakdown voltage	V _{(BR)DSS}	60	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V _{(BR)GSS}	16	_	_	V	$I_{G} = 300 \ \mu A, \ V_{DS} = 0$
Gate to source breakdown voltage	V _{(BR)GSS}	-2.5	_	_	V	$I_G = -100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS1}		_	100	μA	$V_{GS} = 6 V, V_{DS} = 0$
	I _{GSS2}	_	_	50	μA	$V_{GS} = 3.5 \text{ V}, V_{DS} = 0$
	I _{GSS3}	_	_	1	μΑ	$V_{GS} = 1.2 \text{ V}, V_{DS} = 0$
	I _{GSS4}	_	_	-100	μΑ	$V_{GS} = -2.4 \text{ V}, V_{DS} = 0$
Input current (shut down)	I _{GS(op)1}	_	0.6	_	mA	$V_{GS} = 6 V, V_{DS} = 0$
	I _{GS(op)2}	_	0.35	_	mA	$V_{GS} = 3.5 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	10	μA	$V_{DS} = 60 V, V_{GS} = 0$
Gate to source cutoff voltage	V _{GS(off)}	2.2	_	3.4	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Forward transfer admittance	y _{fs}	15	50	_	S	$I_D = 25 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note3}}$
Static drain to source on state resistance	R _{DS(on)}	_	8	12	mΩ	$I_D = 25 \text{ A}, V_{GS} = 10 \text{ V}^{Note3}$
Static drain to source on state resistance	$R_{\text{DS(on)}}$	—	9.5	15	mΩ	$I_D = 25 \text{ A}, V_{GS} = 6 \text{ V}^{Note3}$
Output capacitance	Coss	_	1450	_	pF	$V_{DS} = 10 \text{ V}$, $V_{GS} = 0$, f = 1 MHz
Turn-on delay time	t _{d(on)}	_	20	_	μs	$I_D = 25 \text{ A}, V_{GS} = 10 \text{ V}$
Rise time	t _r		75		μs	$R_{L} = 1.2 \Omega$
Turn-off delay time	t _{d(off)}	_	3	_	μs	
Fall time	t _f	_	2.6	_	μs	
Body-drain diode forward voltage	V _{DF}	_	0.9		V	$I_{\rm F} = 50 \text{ A}, V_{\rm GS} = 0$
Body–drain diode reverse recovery time	t _{rr}	_	110	_	ns	I _F = 50 A, V _{GS} = 0 diF/ dt =50 A/μs
Over load shut down operation time Note4	t _{os}	_	0.8	_	ms	$V_{GS} = 6 V, V_{DD} = 16 V$

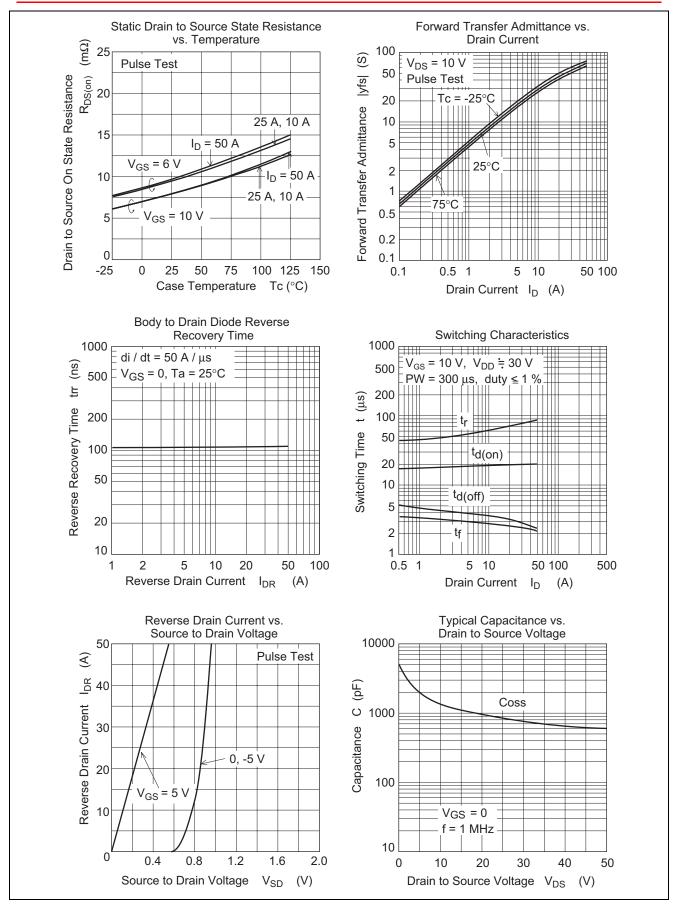
Notes: 3. Pulse test

4. Including the junction temperature rise of the over loaded condition.

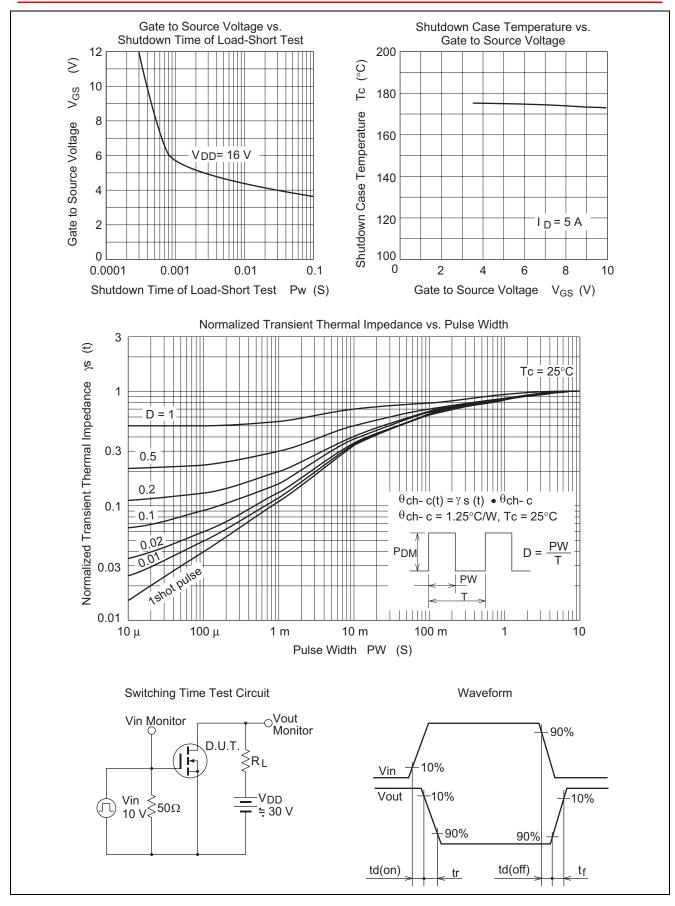
Main Characteristics





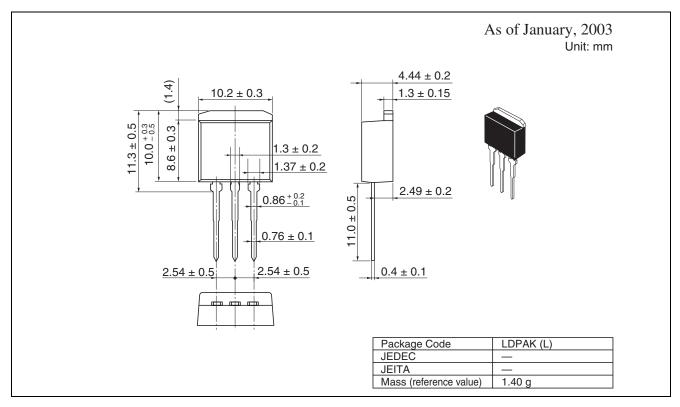


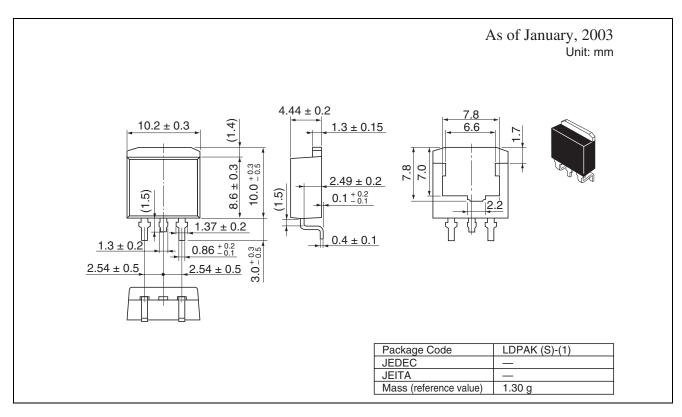






Package Dimensions







HAF2021(L), HAF2021(S)

Ordering Information

Part Name	Quantity	Shipping Container	
HAF2021-90L	Max:50pcs/sack	sack	
HAF2021-90S	Max:50pcs/sack	sack	
HAF2021-90STL	1000pcs/Reel	Embossed tape	
HAF2021-90STR	1000pcs/Reel	Embossed tape	

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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